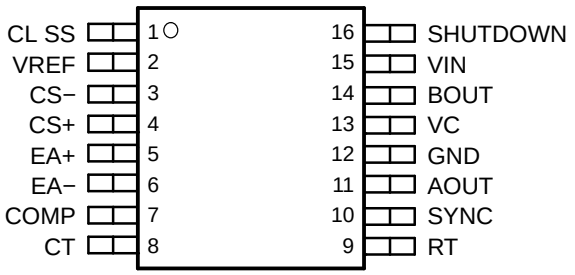
IMPROVED CURRENT MODE PWM CONTROLLER

FEATURES

- **Pin-for-Pin Compatible With the UC2846**
- **65-ns Typical Delay From Shutdown to Outputs and 50-ns Typical Delay From Sync to Outputs**
- **Improved Current Sense Amplifier With Reduced Noise Sensitivity**
- **Differential Current Sense With 3-V Common Mode Range**
- **Trimmed Oscillator Discharge Current for Accurate Deadband Control**
- **Accurate 1-V Shutdown Threshold**
- **High Current Dual Totem Pole Outputs (1.5-A peak)**
- **TTL Compatible Oscillator SYNC Pin Thresholds**
- **4-kV ESD Protection**

DW PACKAGE
(TOP VIEW)



P0008-01

DESCRIPTION

The UC2856 is a high performance version of the popular UC2846 series of current mode controllers, and is intended for both design upgrades and new applications where speed and accuracy are important. All input to output delays have been minimized, and the current sense output is slew rate limited to reduce noise sensitivity. Fast 1.5-A peak output stages have been added to allow rapid switching of power FETs.

A low impedance TTL compatible sync output has been implemented with a 3-state function when used as a sync input.

Internal chip grounding has been improved to minimize internal *noise* caused when driving large capacitive loads. This, in conjunction with the improved differential current sense amplifier, results in enhanced noise immunity.

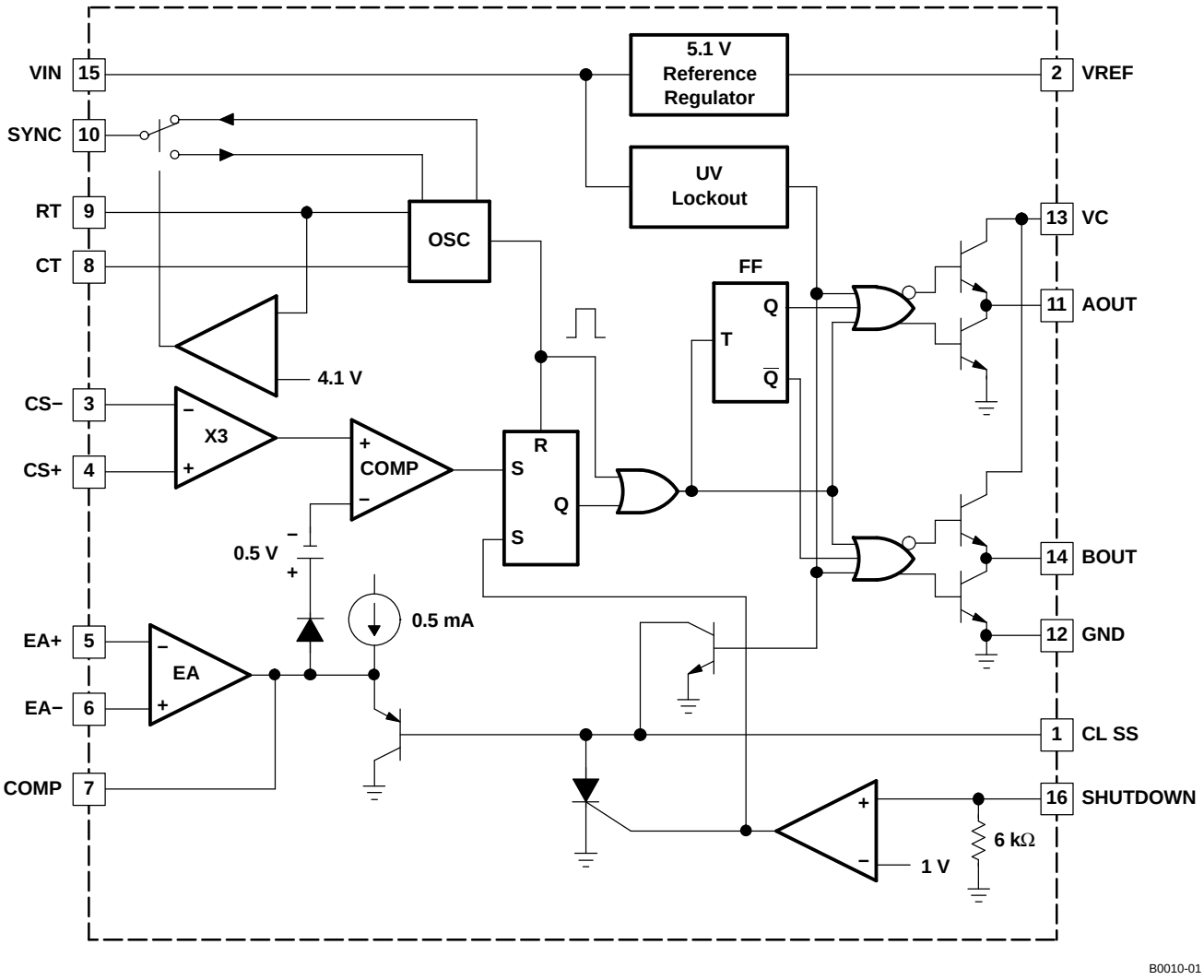
Other features include a trimmed oscillator current (8%) for accurate frequency and dead time control; a 1 V, 5% shutdown threshold; and 4 kV minimum ESD protection on all pins.

ORDERING INFORMATION(1)

T_A	PACKAGE		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 125°C	SOP–DW	Tape and reel	UC2856QDWR	UC2856Q

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

BLOCK DIAGRAM



ORDERING INFORMATION

UC 285 6 Q DW R

- R — Tape and Reel Indicator
- DW — Package: DW = Plastic SOIC
- Q — Temperature Indicator: Q = −40°C to 125°C

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)(1)(2)

			UNIT
	Supply voltage		40 V
	Collector supply voltage		40 V
I_O	Output current (sink or source)	DC	0.5 A
		Pulse (0.5 ms)	2 A
	Error amplifier input voltage		–0.3 V to VIN
	Shutdown input voltage		–0.3 V to 10 V
	Current sense input voltage		–0.3 V to 3 V
	SYNC output current		±10 mA
	Error amplifier output current		-5 mA
	Soft start sink current		50 mA
	Oscillator charging current		5 mA
	Power dissipation	T_A = 25°C	1 W
		T_C = 25°C	2 W
T_J	Operating junction temperature range		–55°C to 150°C
T_{stg}	Storage temperature range		–65°C to 150°C
	Lead temperature soldering 1,6 mm (1/16 inch) from case for 10 seconds		300°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) Unless otherwise indicated, voltages are reference to ground and currents are positive into and negative out of the specified terminals.

ELECTRICAL CHARACTERISTICS

T_A = –40°C to 125°C, VIN = 15 V, RT = 10 kΩ, CT = 1 nF, and $T_A = T_J$ (unless otherwise stated)(1)

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
REFERENCE SECTION						
Output voltage	I_O = 1 mA,	T_J = 25°C	5.05	5.1	5.15	V
Line regulation voltage	VIN = 8 V to 40 V				20	mV
Load regulation voltage	I_O = –1 mA to –10 mA				15	mV
Total output variation	Line, Load, and Temperature		5		5.2	V
Output noise voltage	f = 10 Hz to 10 kHz,	T_J = 25°C		50		µV
Long term stability	1000 hours, (2)	T_J = 25°C		5	25	mV
Short circuit current	VREF = 0 V		–25	–45	–65	mA
OSCILLATOR SECTION						
Initial accuracy	T_J = 25°C		180	200	220	kHz
	T_J = Full range		170		230	
Voltage stability	VIN = 8 V to 40 V				2%	
Discharge current	VCT = 2 V,	T_J = 25°C	7.5	8	8.8	mA
	VCT = 2 V		6.7	8	8.8	
Sync output high level voltage	I_O = –1 mA		2.4	3.6		V
Sync output low level voltage	I_O = 1 mA			0.2	0.4	V
Sync input high level voltage	CT = 0 V, RT = VREF		2	1.5		V
Sync input low level voltage	CT = 0 V, RT = VREF			1.5	0.8	V
Sync input current	CT = 0 V, RT = VREF, V_{SYNC} = 5 V			1	10	µA
Sync delay to outputs	CT = 0 V RT = VREF, V_{SYNC} = 0.8 V to 2 V			50	100	ns

(1) All voltages are with respect to GND. Currents are positive into, negative out of the specified terminal.
(2) This parameter, although specified over the recommended operating conditions, is not 100% tested in production.

ELECTRICAL CHARACTERISTICS (continued)

T_A = –40°C to 125°C, VIN = 15 V, RT = 10 kΩ, CT = 1 nF, and T_A = T_J (unless otherwise stated)

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
ERROR AMPLIFIER SECTION						
Input offset voltage	V_{CM} = 2 V				5	mV
Input bias current					–1	µA
Input offset current					500	nA
Common mode range	VIN = 8 V to 40 V		0		VIN–2	V
Open loop gain	V_O = 1.2 V to 3 V		80	100		dB
Unity gain bandwidth	T_J = 25°C		1	1.5		MHz
CMRR	V_{CM} = 0 V to 38 V,	VIN = 40 V	75	100		dB
PSRR	VIN = 8 V to 40 V		80	100		dB
Output sink current	V_{ID} = -15 mV	V_{COMP} = 1.2 V	5	10		mA
Output source current	V_{ID} = 15 mV	V_{COMP} = 2.5 V	–0.4	–0.5		mA
High-level output voltage	V_{ID} = 50 mV,	R_L (COMP) = 15 kΩ	4.3	4.6	4.9	V
Low-level output voltage	V_{ID} = –50 mV,	R_L (COMP) = 15 kΩ		0.7	1	V
CURRENT SENSE AMPLIFIER SECTION						
Amplifier gain	$V_{CS–}$ = 0 V,	CL SS Open(3)(4)	2.5	2.75	3	V/V
Maximum differential input signal (V_{CS+}– $V_{CS–}$)	CL SS Open 3,	R_L (COMP) = 15 kΩ	1.1	1.2		V
Input offset voltage	$V_{CL\ SS}$ = 0.5 V	COMP open(5)		5	35	mV
CMRR	V_{CM} = 0 V to 3 V		60			dB
PSRR	VIN = 8 V to 40 V		60			dB
Input bias current	$V_{CL\ SS}$ = 0.5 V,	COMP open(5)			–1	µA
Input offset current	$V_{CL\ SS}$ = 0.5 V,	COMP open(5)			1	mA
Input common mode range			0		3	V
Delay to outputs	V_{EA+} = VREF, EA– = 0 V, CS+ – CS– = 0 V to 1.5 V			120	250	ns
CURRENT LIMIT ADJUST SECTION						
Current limit offset	$V_{CS–}$ = 0 V, V_{CS+} = 0 V,	COMP Open(5)	0.4	0.5	0.6	V
Input bias current	V_{EA+} = VREF,	$V_{EA–}$ = 0 V		–10	–30	µA
SHUTDOWN TERMINAL SECTION						
Threshold voltage			0.95	1.00	1.05	V
Input voltage range			0		5	V
Minimum latching current ($I_{CL\ SS}$)			(6)3	1.5		mA
Maximum non-latching current ($I_{CL\ SS}$)				(7)1.5	0.8	mA
Delay to outputs	$V_{SHUTDOWN}$ = 0 V to 1.3 V			65	110	ns
OUTPUT SECTION						
Collector-emitter voltage			40			V
Off-state bias current	VC = 40 V				250	µA
Output low level voltage	I_{OUT} = 20 mA			0.1	0.5	V
	I_{OUT} = 200 mA			0.5	2.6	
Output high level voltage	I_{OUT} = –20 mA		12.5	13.2		V
	I_{OUT} = –200 mA		12	13.1		
Rise time	C1 = 1 nF			40	80	ns
Fall time	C1 = 1 nF			40	80	ns

(3) Parameter measured at trip point of latch with VEA+ = VREF, VEA- = 0 V.

(4) Amplifier gain defined as: $G = \frac{\Delta V_{COMP}}{\Delta V_{CS+}}$; $\Delta V_{CS-} = 0\ V\ 1\ V$.

(5) Parameter measured at trip point of latch with VEA+ = VREF, VEA- = 0 V.

(6) Current into CL SS assured to latch circuit into shutdown state.

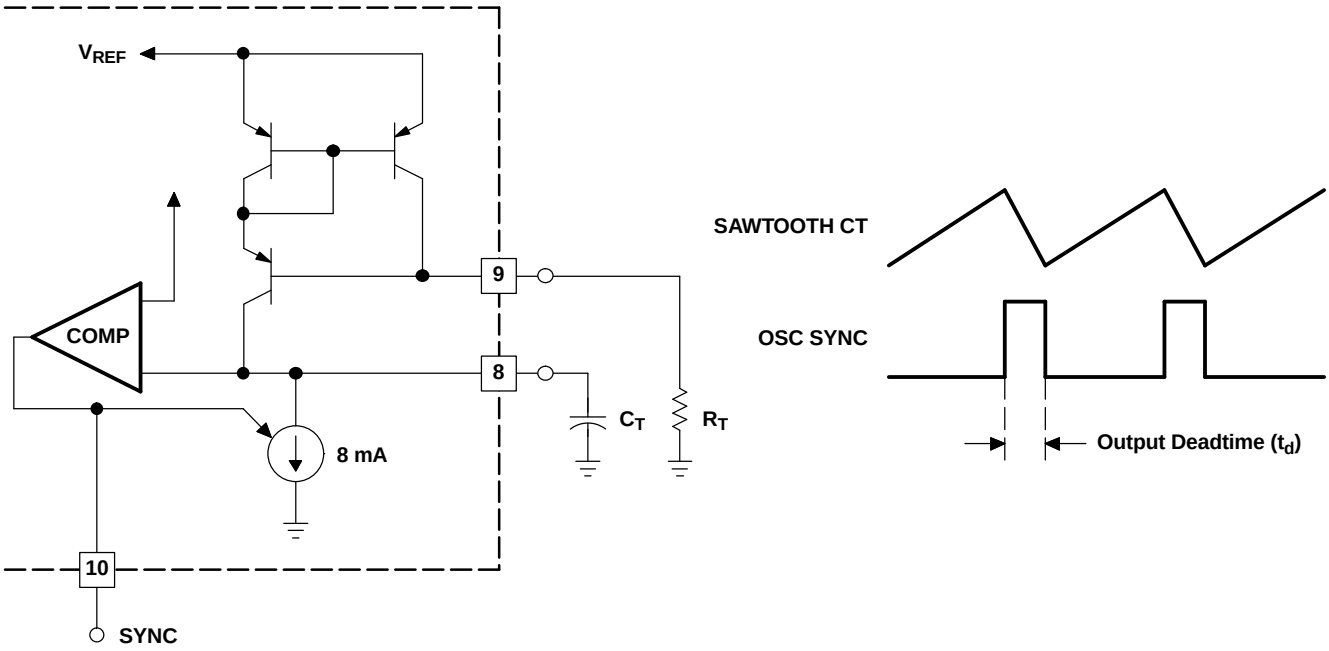
(7) Current into CL SS assured not to latch circuit into shutdown state.

ELECTRICAL CHARACTERISTICS (continued)

T_A = –40°C to 125°C, VIN = 15 V, RT = 10 kΩ, CT = 1 nF, and T_A = T_J (unless otherwise stated)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
UVLO low saturation	VIN = 0 V, I_{OUT} = 20 mA		0.8	1.5	V
PWM SECTION					
Maximum duty cycle		45%	47%	50%	
Minimum duty cycle				0%	
UNDERVOLTAGE LOCKOUT SECTION					
Startup threshold			7.7	8	
Threshold hysterisis			0.7		
TOTAL STANDBY CURRENT					
Supply current			18	23	mA

APPLICATION AND OPERATION INFORMATION



NOTE: Output deadtime is determined by the size of the external capacitor, C_T, according to the formula: $Td = \frac{2C_T}{8\ mA - \frac{3.6}{R_T}}$

For large values of R_T: $Td = 250\ C_T$

Oscillator frequency is approximated by the formula: $f_T = \frac{2}{R_T \times C_T}$

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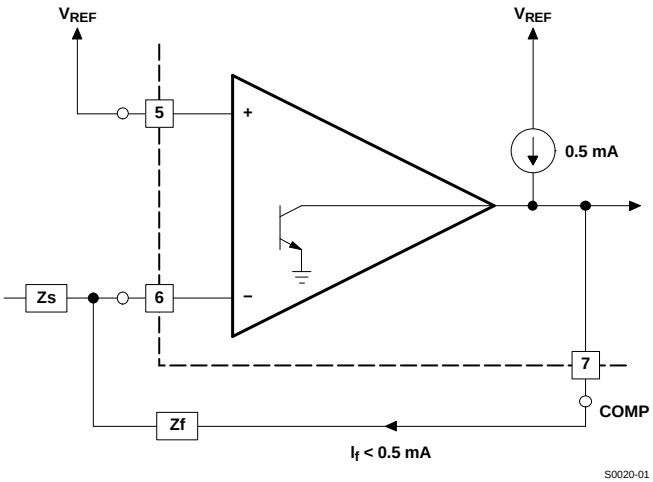
Figure 1. Oscillator Circuit



NOTE: Error Amplifier can source up to 0.5 mA.

Figure 2. Error Amplifier Output Configuration

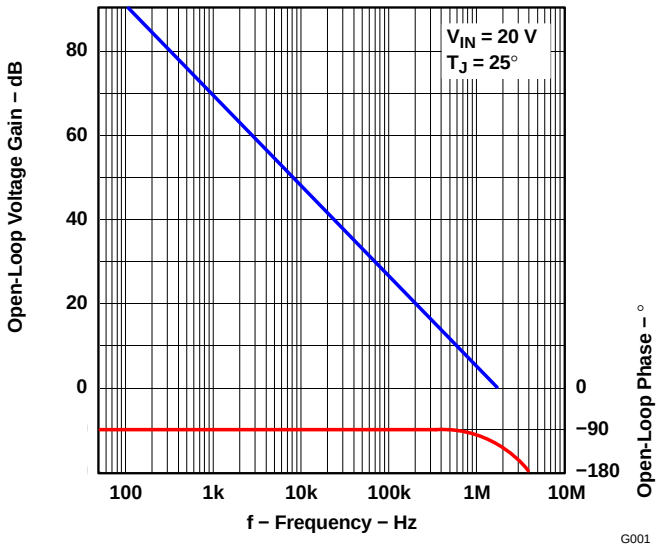


Figure 3. Error Amplifier Gain and Phase vs Frequency

APPLICATION AND OPERATION INFORMATION (continued)

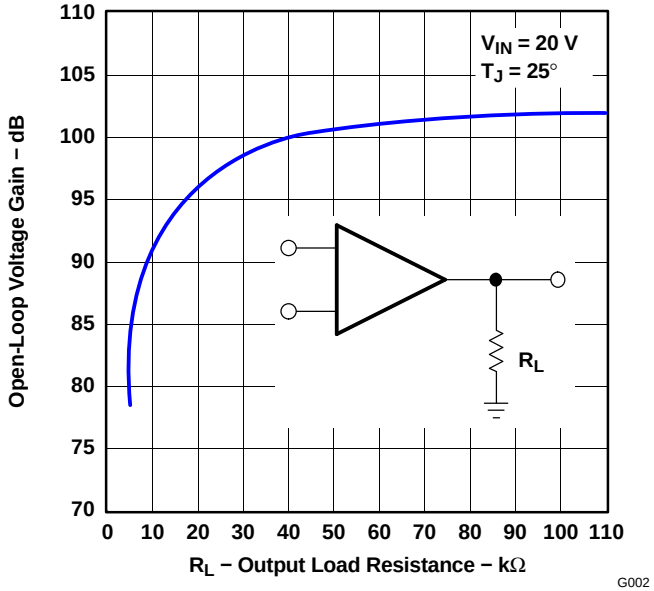
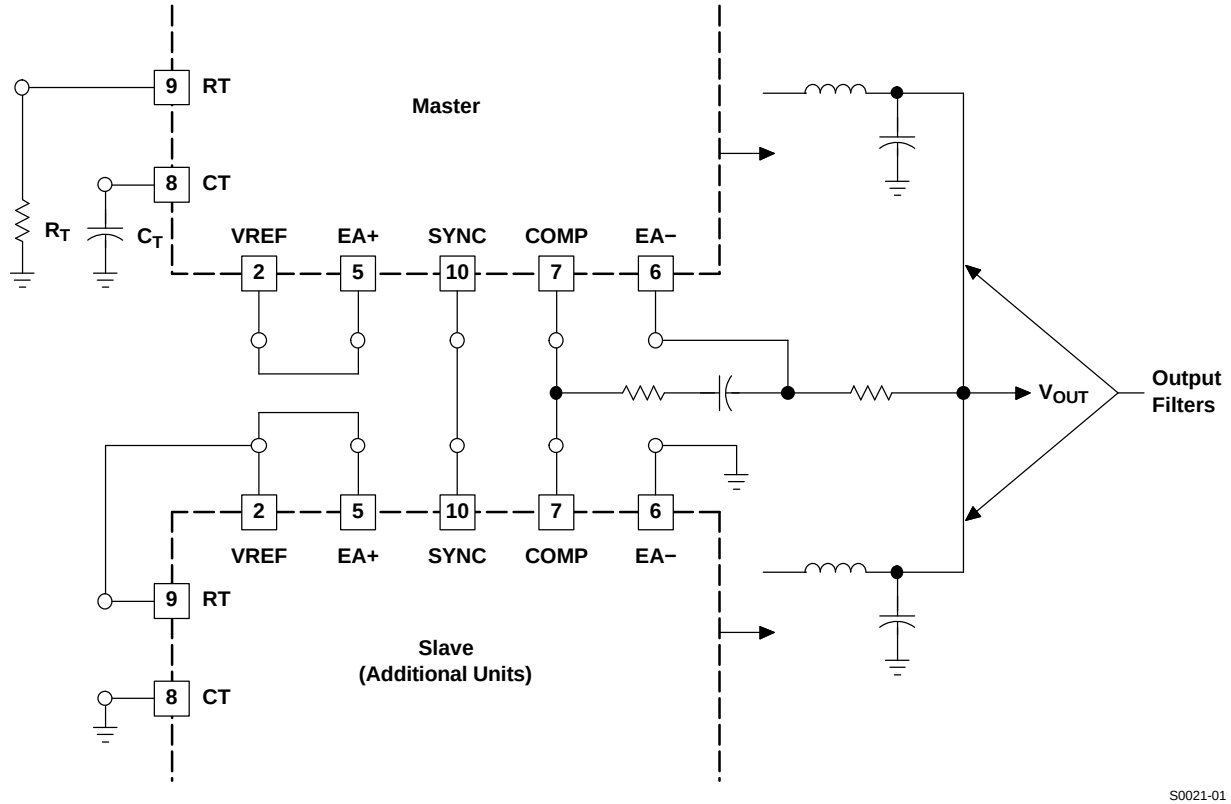


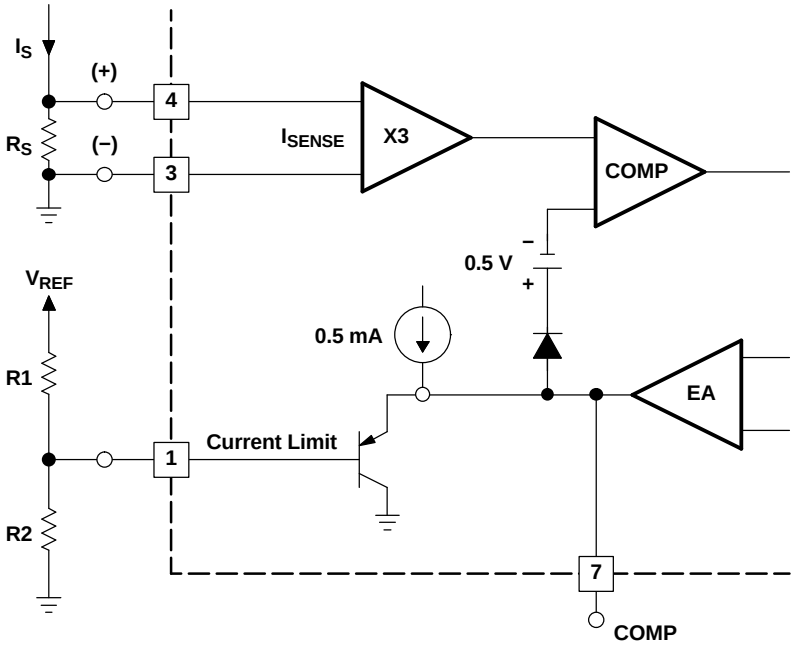
Figure 4. Error Amplifier Open-Loop DC Gain vs Load Resistance



NOTE: Slaving allows parallel operation of two or more units with equal current sharing.

Figure 5. Parallel Operation

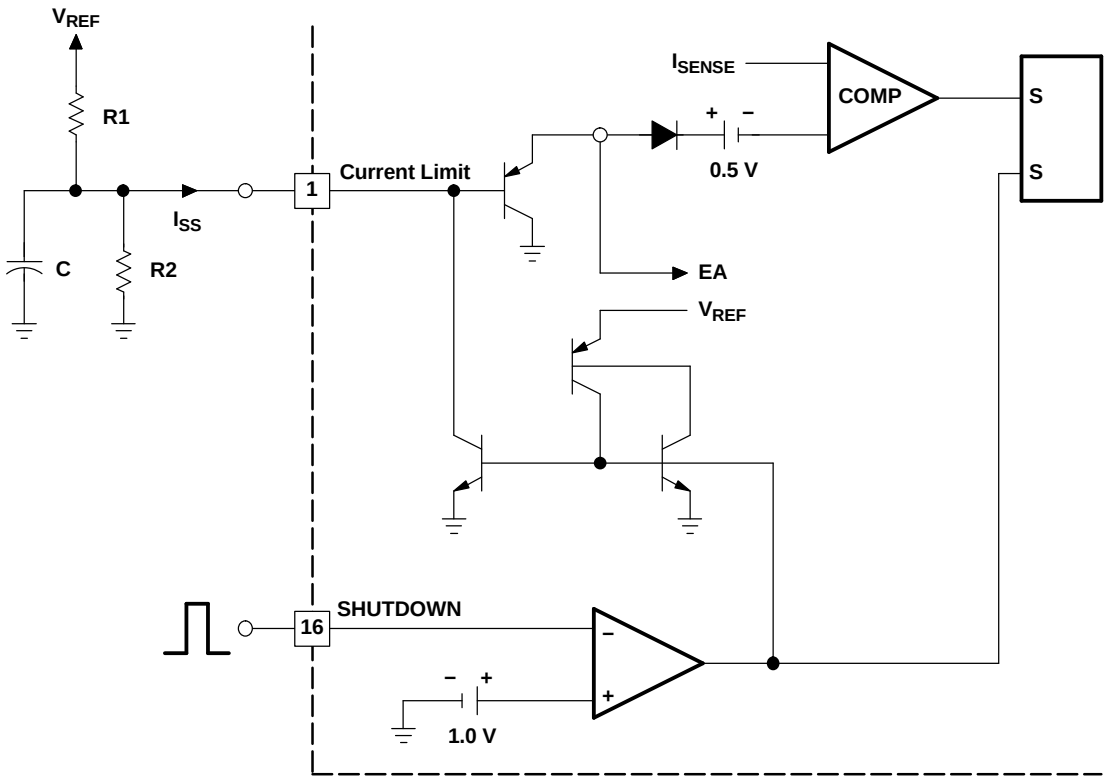
APPLICATION AND OPERATION INFORMATION (continued)

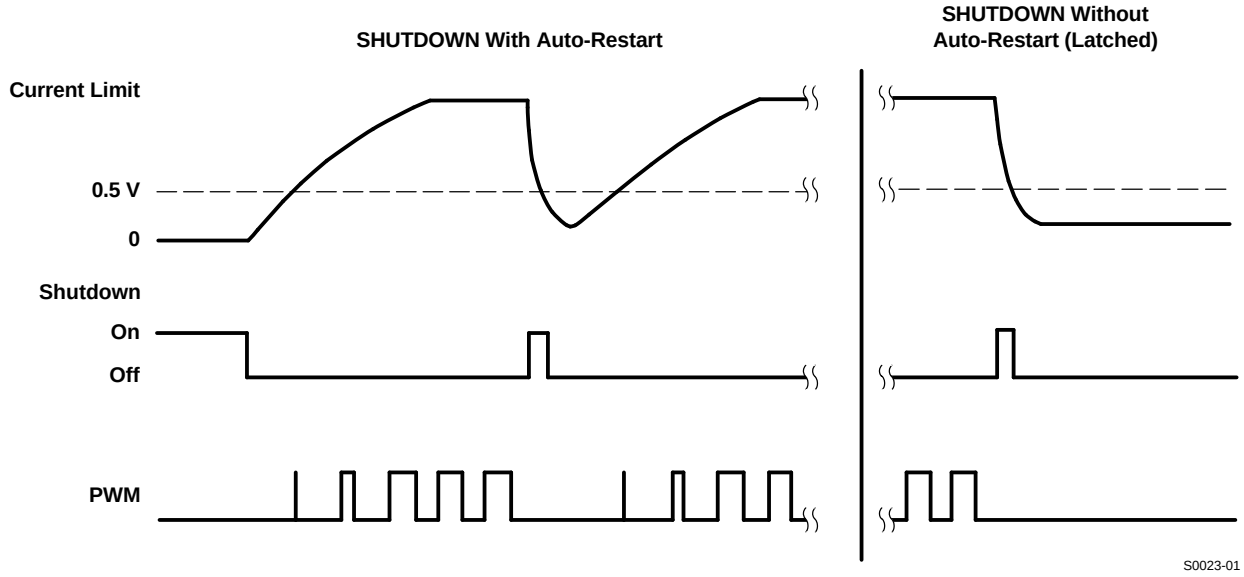


NOTE: Peak current (I_S) is determined by the formula: $$I_S = \frac{\left(R2 \times \frac{V_{REF}}{R1 + R2}\right) - 0.5}{3R_S}$$

Figure 6. Pulse by Pulse Current Limiting

APPLICATION AND OPERATION INFORMATION (continued)





NOTE: If V_{REF} / R1 < 0.8 mA, the shutdown latch commutates when I_{SS} = 0.8 mA and a restart cycle will be initiated. If V_{REF} / R1 > 3 mA, the device will latch off until power is recycled.

Figure 7. Shutdown

PACKAGING INFORMATION

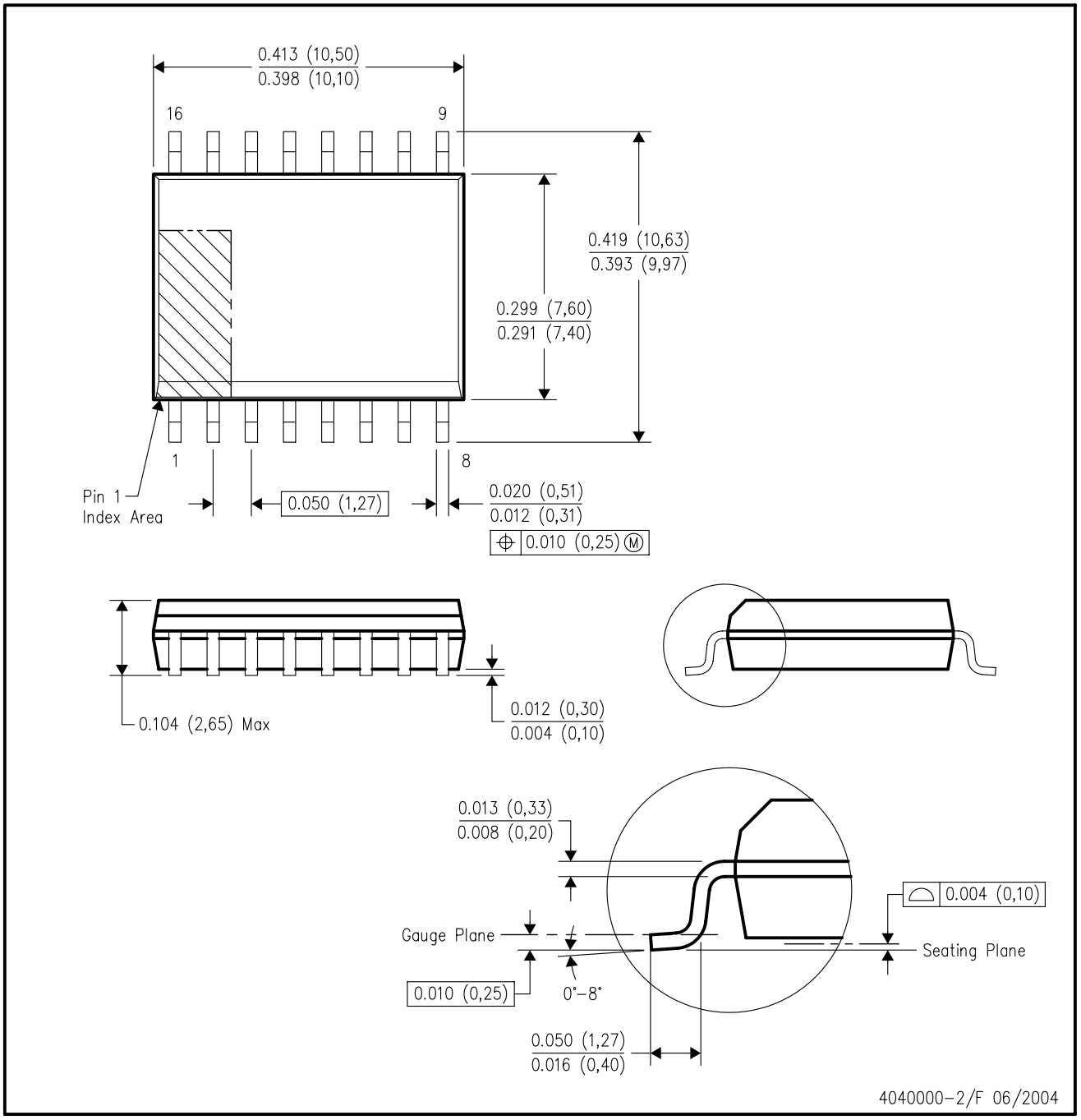
Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
UC2856QDWR	ACTIVE	SOIC	DW	16	2000	TBD	CU SNPB	Level-2-220C-1 YEAR

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

DW (R–PDSO–G16) PLASTIC SMALL–OUTLINE PACKAGE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
D. Falls within JEDEC MS–013 variation AA.

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